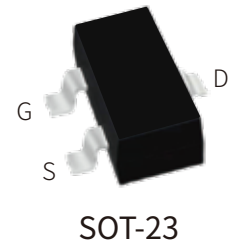


FEATURES

- | Fast switching

- | Ultra Low On-Resistance

- | Surface Mount device



APPLICATION

- | Case: SOT-23

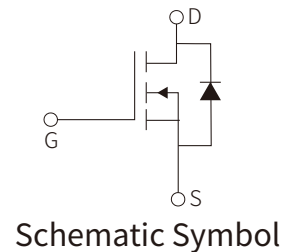
- | Case Material: Molded Plastic, UL flammability

- | Classification Rating: 94V-0



APPROVALS

RoHS	Compliance with 2011/65/EU
HF	Compliance with IEC61249-2-21:2003



ABSOLUTE MAXIMUM RATINGS($T_a=25^{\circ}\text{C}$)

Parameter	Symbol	Value	Unit
Drain-Source Voltage	V_{DS}	20	V
Continuous drain current	I_D	4.2	A
Pulsed Drain Voltage (Note 1)	I_{DM}	33	A
Gate-Source Voltage	V_{GS}	± 12	V
Power dissipation	P_D	1.25	W
Thermal resistance from Junction to ambient	$R_{\theta JA}$	100	$^{\circ}\text{C}/\text{W}$
Junction temperature	T_J	150	$^{\circ}\text{C}$
Storage temperature	T_{STG}	-55 to 150	$^{\circ}\text{C}$

ELECTRICAL CHARACTERISTICS($T_a=25^{\circ}\text{C}$)

Parameter	Symbol	Test Conditions	Min.	Typ.	Max.	Unit
Drain-source Breakdown Voltage	BV_{DSS}	$V_{GS}=0V, I_D=250\mu A$	20			V
Zero Gate Voltage Drain Current	I_{DSS}	$V_{DS}=16V, V_{GS}=0V$			1	μA
Gate-Body Leakage	I_{GSS}	$V_{GS}=\pm 12V, V_{DS}=0V$			± 100	nA
Gate Threshold Voltage (Note1)	$V_{GS(th)}$	$V_{DS}=V_{GS}, I_D=250\mu A$	0.6		1.2	V
Static Drain-Source On-Resistance(Note1)	$R_{DS(on)}$	$V_{GS}=4.5V, I_D=4.2A$		35	45	m Ω
		$V_{GS}=2.5V, I_D=3.6A$		50	80	
Forward Transconductance(Note1)	g_{FS}	$V_{DS}=10V, I_D=4A$		2.8		S
Input Capacitance	C_{iss}	$V_{DS}=15V, V_{GS}=0V, f=1.0\text{MHz}$		740		pF
Output Capacitance	C_{oss}			90		
Reverse Transfer Capacitance	C_{rss}			66		
Turn-On Delay Time	$t_{d(on)}$	$R_L=10\Omega, R_{GEN}=6\Omega$ $V_{DD}=10V, I_D=1A$		7.5		ns
Turn-On Rise Time	t_r			10		
Turn-Off Delay Time	$t_{d(off)}$			54		
Turn-Off Fall Time	t_f			26		
Diode forward voltage (note 1)	V_{SD}	$I_S=1.3A, V_{GS}=0V, T_J=25^{\circ}\text{C}$			1.2	V
Total Gate Charge	Q_g	$V_{GS}=5V, V_{DS}=10V, I_D=4A$		8	12	nC
Gate Source Charge	Q_{gs}			1.8	2.7	
Gate Drain Charge	Q_{gd}			1.7	2.6	
Diode forward current	I_S				1.3	A

Note:1. Pulse test ; Pulse width $\leq 300\mu s$, Duty cycle $\leq 2\%$

PARAMETER CHARACTERISTIC CURVE

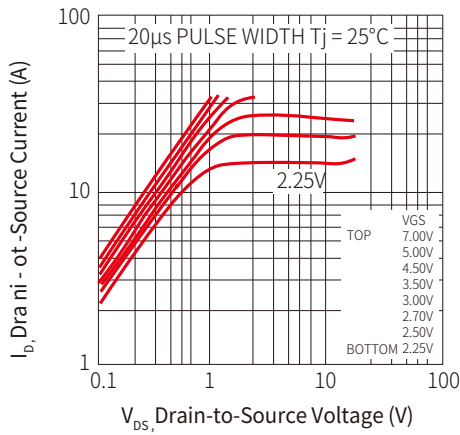
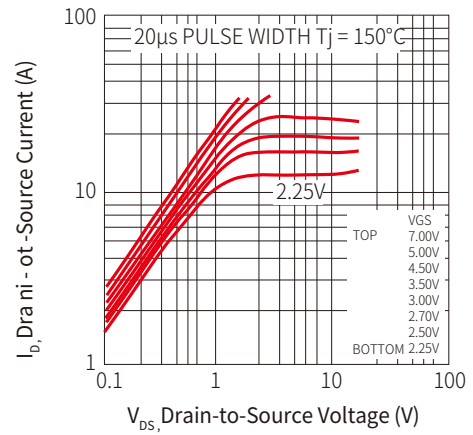
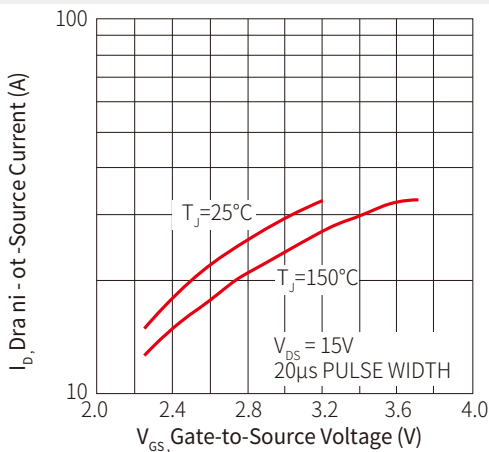
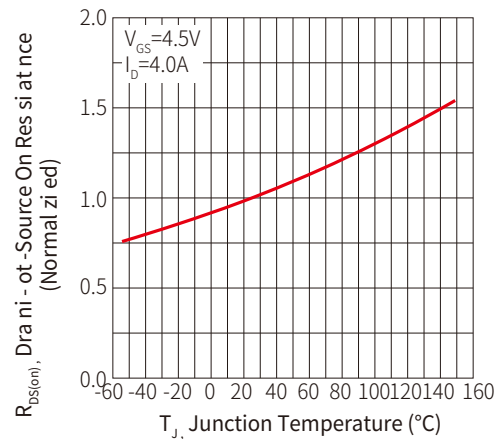
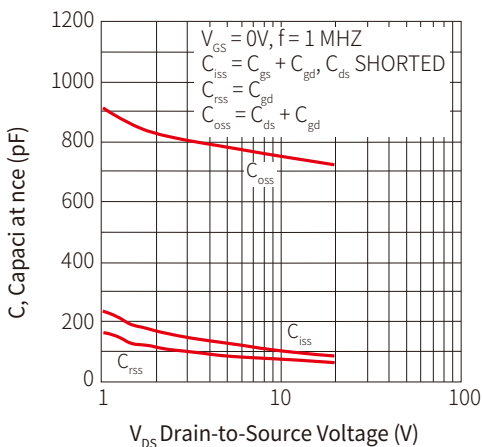
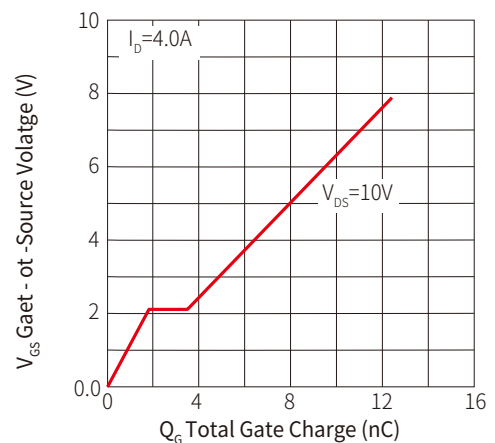
Fig 1: Typical Output Characteristics

Figure 2: Typical Output Characteristics

Figure 3: Typical Transfer Characteristics

Figure 4: Normalized On-Resistance Vs. Temperature

Figure 5: Typical Capacitance Vs. Drain-to-Source Voltage

Figure 6: Typical Gate Charge Vs. Gate-to-Source Voltage


Figure 7: Typical Source-Drain Diode Forward Voltage

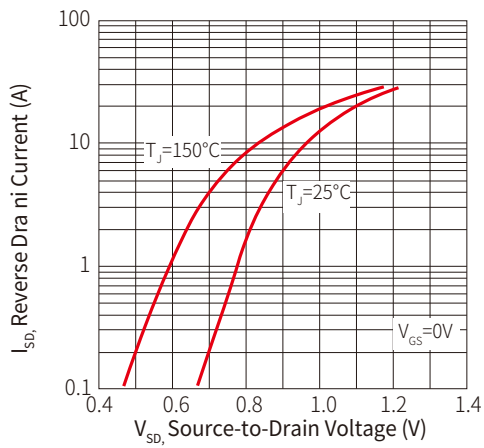


Figure 8: Maximum Safe Operating Area

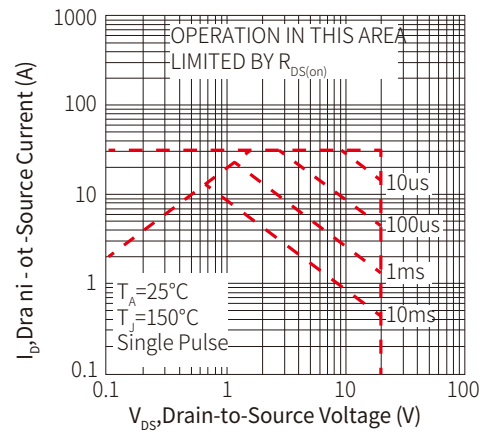


Figure 9: Maximum Drain Current Vs. Case Temperature

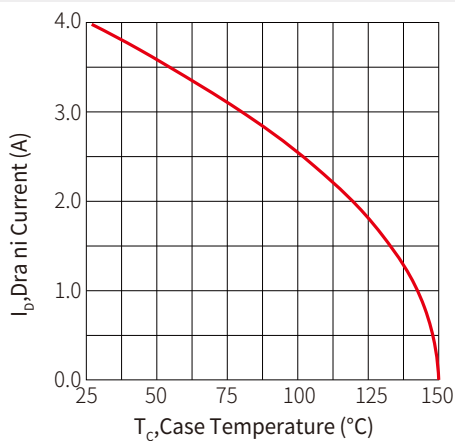
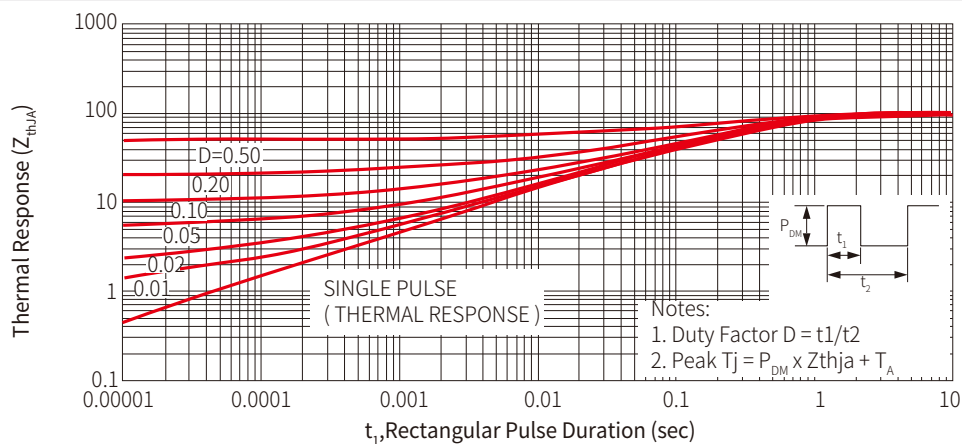
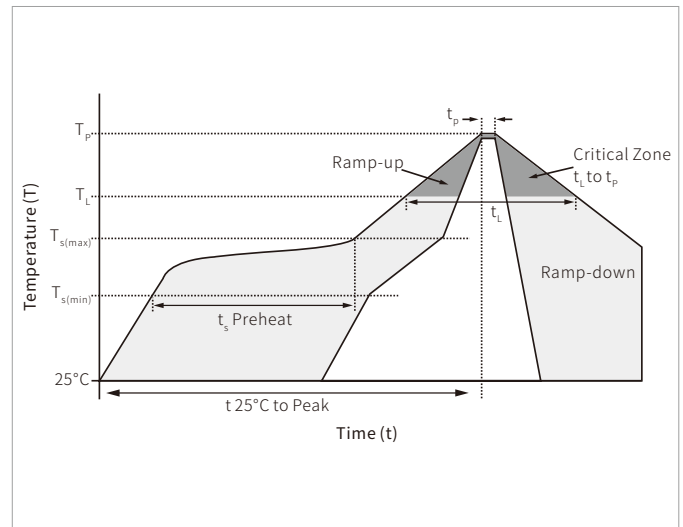


Figure 10: Maximum Effective Transient Thermal Impedance, Junction-to-Ambient

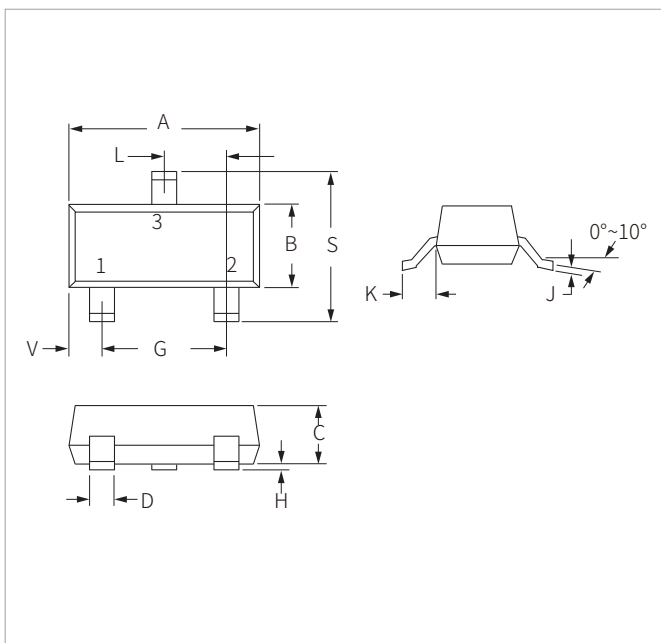


SOLDERING PARAMETERS

Reflow Condition		Lead-free assembly
Pre Heat	Temperature Max ($T_{s(min)}$)	150°C
	Temperature Max ($T_{s(max)}$)	200°C
	Time (min to max) (t_s)	60 – 180 secs
Average ramp up rate (Liquidus Temp (T_L) to peak)		3°C/second max
$T_{s(max)}$ to T_L - Ramp-up Rate		3°C/second max
Reflow	Temperature (T_L) (Liquidus)	217°C
	Time (min to max) (t_l)	60 – 150 seconds
Peak Temperature (T_p)		260°C
Time within 5°C of actual peak Temperature (t_p)		20 – 40 seconds
Ramp-down Rate		6°C/second max
Time 25°C to peak Temperature (T_p)		8 minutes max.
Do not exceed		260°C

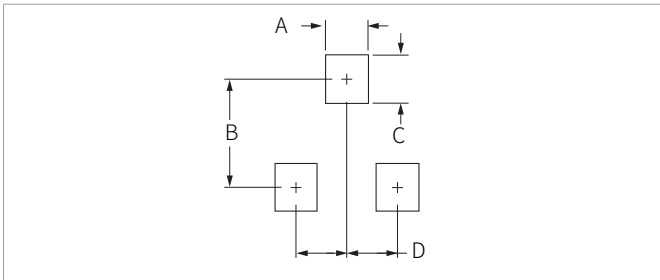


SOT-23 PACKAGE INFORMATION



Ref.	Millimeters		Inches	
	Min.	Max.	Min.	Max.
A	2.80	3.05	0.110	0.120
B	1.20	1.40	0.047	0.055
C	0.90	1.15	0.035	0.045
D	0.37	0.50	0.015	0.020
G	1.75	2.05	0.069	0.081
H	0.01	0.100	0.001	0.004
J	0.085	0.180	0.003	0.007
K	0.35	0.69	0.014	0.029
L	0.89	1.02	0.035	0.040
S	2.10	2.65	0.083	0.104
V	0.45	0.60	0.018	0.024

RECOMMENDED PAD LAYOUT DIMENSIONS



Ref.	Millimeters		Inches	
	Min.	Max.	Min.	Max.
A	0.71	0.97	0.028	0.038
B	1.88	2.13	0.074	0.084
C	0.71	0.97	0.028	0.038
D	0.81	1.07	0.032	0.042

ORDERING INFORMATION

Part Number	Component Package	QTY/Reel	Reel Size
SNM2502S	SOT-23	3000PCS	7"

Headquarters

No.3387 Shendu Road
Pujiang I&E Park
Minhang Shanghai China
201000

Hotline

400-021-5756

Web

<https://www.semiware.com>

Sales Center

Tel: 86-21-3463-7458
Email: sales18@semiware.com

Customer Service

Tel: 86-21-5484-1001
Email: sales17@semiware.com

Technical Support

Tel: 86-21-3463-7654
Email: fae01@semiware.com

Complaint & Suggestions

Tel: 86-21-3463-7172
Ext: 8868
Email: cs03@semiware.com

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